



# SOT878-2

plastic rectangular-DIL-bent-SIL (reverse bent) power package; 27 leads (row spacing 2.54 mm)

8 February 2016

Package information

## 1. Package summary

<b>Terminal position code</b>	Z (zig-zag)
<b>Package type descriptive code</b>	RDBS27P
<b>Package type industry code</b>	RDBS27P
<b>Package style descriptive code</b>	RDBS (right-angle DIL-bent-SIL)
<b>Package style suffix code</b>	P (power)
<b>Package body material type</b>	P (plastic)
<b>Mounting method type</b>	T (through-hole mount)
<b>Issue date</b>	19-12-2012

Table 1. Package summary

Symbol	Parameter	Min	Typ	Nom	Max	Unit
D	package length	28.8	-	29	29.2	mm
E	package width	15.5	-	15.7	15.9	mm
A <sub>2</sub>	package height	4.35	-	4.5	4.65	mm
e	nominal pitch	-	-	2	-	mm
n <sub>2</sub>	actual quantity of termination	-	-	27	-	



plastic rectangular-DIL-bent-SIL (reverse bent)  
power package; 27 leads (row spacing 2.54 mm)

## 2. Package outline

RDBS27P: plastic rectangular-DIL-bent-SIL (reverse bent) power package; 27 leads (row spacing 2.54 mm) SOT878-2

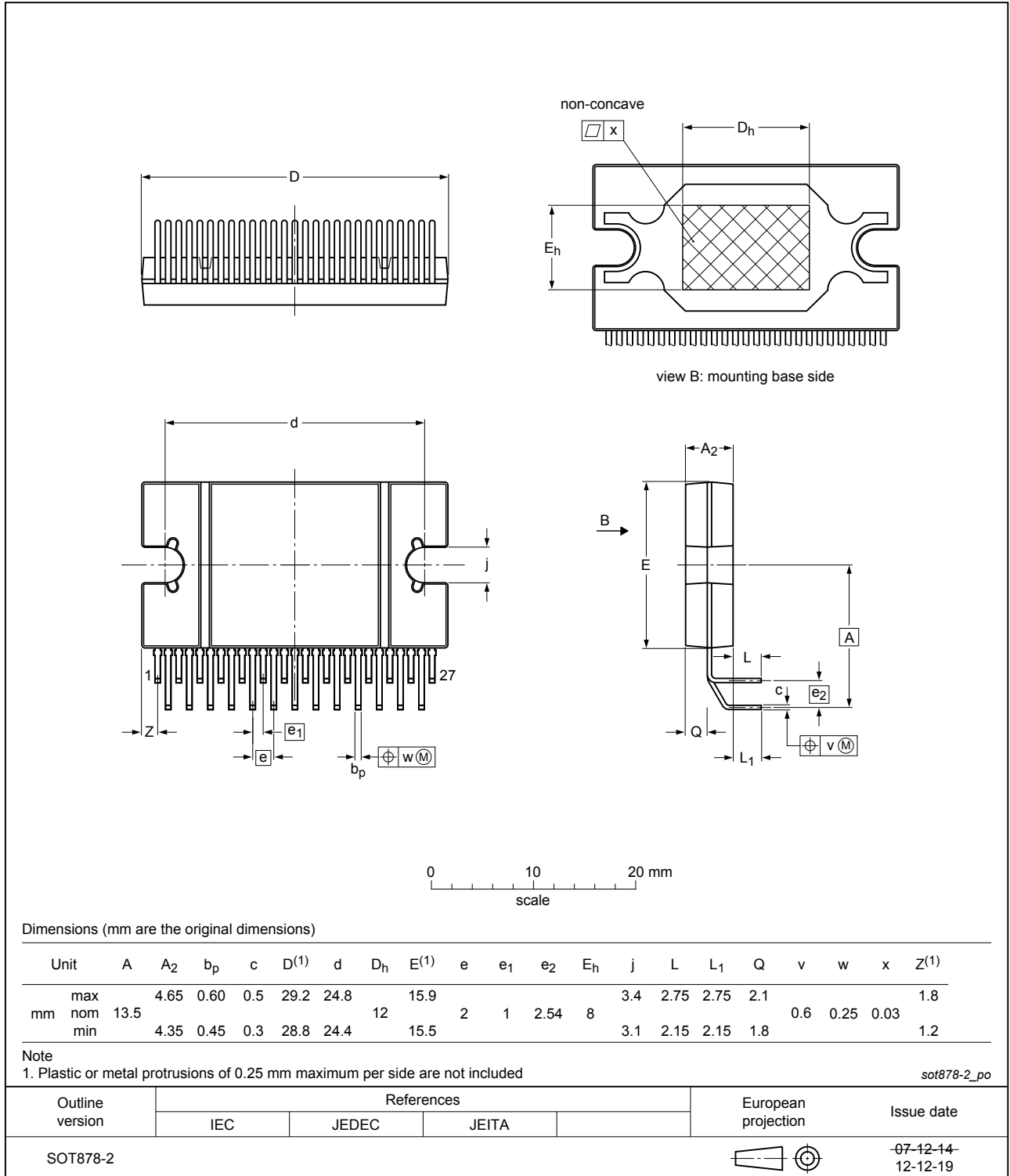


Fig. 1. Package outline RDBS27P (SOT878-2)

### 3. Legal information

---

#### Disclaimers

**Limited warranty and liability** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

**Right to make changes** — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

plastic rectangular-DIL-bent-SIL (reverse bent)  
power package; 27 leads (row spacing 2.54 mm)

## 4. Contents

---

1. Package summary.....	1
2. Package outline.....	2
3. Legal information.....	3

---

© NXP Semiconductors N.V. 2016. All rights reserved

For more information, please visit: <http://www.nxp.com>  
For sales office addresses, please send an email to: [salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)  
Date of release: 8 February 2016

---